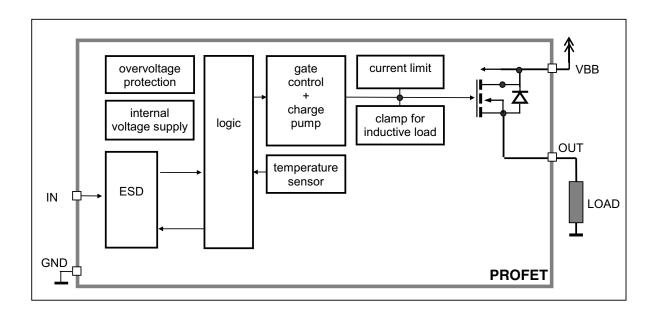


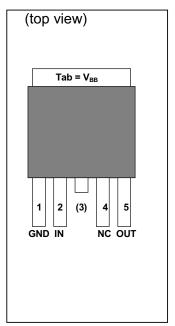
### Functional diagram



### **Pin Definitions and Functions**

Pin	Symbol	Function		
1	GND Logic ground			
2	IN	<b>Input</b> , activates the power switch in case of logical high signal		
3	V <sub>bb</sub>	<b>Positive power supply voltage</b> The tab is shorted to pin 3		
4	N.C.	Not connected		
5	OUT	Output to the load		
Tab	V <sub>bb</sub>	<b>Positive power supply voltage</b> The tab is shorted to pin 3		

### **Pin configuration**





Parameter	Symbol	Values	Unit
Supply voltage (overvoltage protection see page 4)	V <sub>bb</sub>	43	V
Supply voltage for full short circuit protection <i>T</i> <sub>j Start</sub> =-40+150°C	V <sub>bb</sub>	34	V
Load dump protection <sup>1)</sup> $V_{\text{LoadDump}} = V_{\text{A}} + V_{\text{S}}, V_{\text{A}} = 13.5 \text{ M}$ $R_{\text{I}}^{2)} = 2 \Omega, R_{\text{L}} = 0.5 \Omega, t_{\text{d}} = 200 \text{ ms}, \text{IN} = \text{low or high}$	/ V <sub>Load dump</sub> <sup>3)</sup>	60	V
Load current (Short-circuit current, see page 5)	IL	self-limited	A
Operating temperature range Storage temperature range	T <sub>j</sub> T <sub>stg</sub>	-40+150 -55+150	°C
Power dissipation (DC) ; TC≤25°C	P <sub>tot</sub>	125	W
Maximal switchable inductance, single pulse $V_{bb} = 12V$ , $T_{j,start} = 150^{\circ}C$ , $T_{C} = 150^{\circ}C$ const. (see diagram, p.8) $I_{L(ISO)} = 21$ A, RL= 0 $\Omega$ : $E^{4}_{AS} = 0.7$ J	: Z <sub>L</sub>	2.1	mH
Electrostatic discharge capability (ESD)IN:(Human Body Model)Out to all other pins shorted:acc. MIL-STD883D, method 3015.7 andESD assn. std. S5.1-1993; R=1.5kΩ; C=100pF	V <sub>ESD</sub>	1.0 8.0	kV
Input voltage (DC)	V <sub>IN</sub>	-10 +16	V
Current through input pin (DC) see internal circuit diagrams page 7	l <sub>in</sub>	±2.0	mA
Thermal resistance chip - case		≤ 1 < 75	K/W
junction - ambient (free air)	: R <sub>thJA</sub>	≤ 75	
SMD version, device on pcb <sup>5</sup>	:	≤ <b>33</b>	

<sup>&</sup>lt;sup>1)</sup> Supply voltages higher than  $V_{bb(AZ)}$  require an external current limit for the GND pin, e.g. with a 150  $\Omega$  resistor in the GND connection. A resistor for the protection of the input is integrated.

<sup>2)</sup>  $R_{\rm l}$  = internal resistance of the load dump test pulse generator

<sup>4)</sup>  $E_{AS}$  is the maximum inductive switch off energy

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<sup>&</sup>lt;sup>3)</sup> V<sub>Load dump</sub> is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

<sup>&</sup>lt;sup>5)</sup> Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70µm thick) copper area for V<sub>bb</sub> connection. PCB is vertical without blown air.



### **Electrical Characteristics**

Parameter and Conditions	Symbol		Values	;	Unit
at $T_j$ =-40+150°C, $V_{bb}$ = 12 V unless otherwise specified		min	typ	max	

#### Load Switching Capabilities and Characteristics

On-state resistance (V <sub>bb</sub> (pin3) to OUT (pin5)); $I_{L} = 2 \text{ A } V_{bb} \ge 7V$ : $T_{j} = 150 \text{ °C}$ : $T_{j} = 150 \text{ °C}$ :	R <sub>ON</sub>		15 28	20 37	mΩ
see diagram page 9					
Nominal load current (pin 3 to 5) 'ISO 10483-1, 6.7: <i>V</i> <sub>on</sub> =0.5V, <i>T</i> <sub>c</sub> =85°C	I <sub>L(ISO)</sub>	17	21		A
Output current (pin 5) while GND disconnected or GND pulled up <sup>6</sup> ), $V_{bb}$ =30 V, $V_{IN}$ = 0, see diagram page 7	I <sub>L(GNDhigh)</sub>			2	mA
Turn-on timeINto 90% $V_{OUT}$ :Turn-off timeINto 10% $V_{OUT}$ : $R_L = 12 \Omega$ , $\Omega$ ,	t <sub>on</sub> t <sub>off</sub>	40 40	90 110	200 250	μs
Slew rate on 10 to 30% $V_{OUT}$ , $R_L = 12 \Omega$ ,	dV/dt <sub>on</sub>	0.1		1	V/µs
Slew rate off 70 to 40% $V_{\text{OUT}}$ , $R_{\text{L}}$ = 12 $\Omega$ ,	-d <i>V</i> /dt <sub>off</sub>	0.1		1	V/µs

#### **Operating Parameters**

T 1000					
/j =-40°C	$V_{\rm bb(on)}$	4.75		41	V
<i>T</i> i <sup>'</sup> =+25°C		4.75		43	
$T_{i} = +105^{\circ}C^{6}$		4.75		43	
, 7j =+150°C		5.0		43	
<i>T</i> <sub>i</sub> =-40°C:	V <sub>bb(AZ)</sub>	41			V
<i>T</i> <sub>j</sub> =+25+150°C:		43	47	52	
<i>T</i> <sub>i</sub> =-40+25°C:	I <sub>bb(off)</sub>		5	10	μA
<sup>7</sup> <i>T</i> <sub>i</sub> =+105°C <sup>6</sup> ):				10	•
, Tj=+150°C:				25	
Off-State output current (included in <i>I</i> <sub>bb(off)</sub> )			1.5	10	μA
Operating current (Pin 1) <sup>9)</sup> , $V_{IN}=5$ V,			2	4	mA
	$\frac{T_{j} = +150^{\circ}C}{T_{j} = -40^{\circ}C:}$ $\frac{T_{j} = +25+150^{\circ}C:}{T_{j} = +40+25^{\circ}C:}$ $\frac{T_{j} = +105^{\circ}C^{6}:}{T_{j} = +150^{\circ}C:}$ ed in $I_{bb(off)}$	$\begin{array}{c c} T_{j} = +105^{\circ}C^{6)} \\ T_{j} = +150^{\circ}C \\ \hline T_{j} = +40^{\circ}C: & V_{bb(AZ)} \\ \hline T_{j} = +25+150^{\circ}C: \\ \hline T_{j} = +40+25^{\circ}C: \\ T_{j} = +105^{\circ}C^{6):} \\ T_{j} = +105^{\circ}C^{6):} \\ \hline T_{j} = +150^{\circ}C: \\ \hline ed \text{ in } I_{bb(off)} \\ \hline I_{L(off)} \\ \hline \end{array}$	$\begin{array}{c c} T_{j} = +25^{\circ}\text{C} & 4.75 \\ T_{j} = +105^{\circ}\text{C}^{6)} & 4.75 \\ 4.75 \\ 5.0 \\ \hline T_{j} = +150^{\circ}\text{C} & 41 \\ \hline T_{j} = +25+150^{\circ}\text{C} & 43 \\ \hline T_{j} = -40+25^{\circ}\text{C} & 43 \\ \hline T_{j} = -40+25^{\circ}\text{C} & 43 \\ \hline T_{j} = +105^{\circ}\text{C}^{6)} & \\ \hline T_{j} = +105^{\circ}\text{C} & \\ \hline T_{j} = +150^{\circ}\text{C} & \\ \hline ed \text{ in } I_{bb(off)} & \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

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<sup>&</sup>lt;sup>6)</sup> not subject to production test, specified by design

 $<sup>^{7)}</sup>$  see also  $V_{\rm ON(CL)}$  in table of protection functions and circuit diagram page 7

 $<sup>^{8)}</sup>$   $\,$  Measured with load, typ. 40  $\mu A$  without load.

<sup>&</sup>lt;sup>9)</sup> Add  $I_{\rm IN}$ , if  $V_{\rm IN}$ >5.5 V



Parameter and Conditions	Symbol	Values			Unit
at $T_j$ =-40+150°C, $V_{bb}$ = 12 V unless otherwise specified		min	typ	max	
Protection Functions <sup>10)</sup>					
Current limit (pin 3 to 5)	I <sub>L(lim)</sub>				
(see timing diagrams, page 9) $T_j = -40^{\circ}C$ $T_j = 25^{\circ}C$ $T_j = +150^{\circ}C$		  40	 65 	85  	A
Repetitive short circuit current limit	I <sub>L(SCr)</sub>		55		Α
$T_{\rm j} = T_{\rm jt}$ (see timing diagrams, page 10)					
Thermal shutdown time <sup>11)12)</sup> <i>T</i> <sub>j,start</sub> =25°C	T <sub>off(SC)</sub>		14		ms
(see timing diagram on page 10)					
Output clamp (inductive load switch off); $T_j = -40^{\circ}C$ at VOUT = Vbb - VON(CL), $I_L = 40 \text{ mA}$ $T_j = 25150^{\circ}C$	V <sub>ON(CL)</sub>	41 43	 47	 52	V
Thermal overload trip temperature	T <sub>jt</sub>	150			°C
Thermal hysteresis	$\Delta T_{jt}$		10		K
Reverse battery (pin 3 to 1) 13)	-V <sub>bb</sub>			32	V
Reverse battery voltage drop $(V_{OUT} > V_{bb})$ $I_L = -2A$ $T_j = +150^{\circ}C$	-V <sub>ON(rev)</sub>		540		mV

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<sup>&</sup>lt;sup>10)</sup> Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

<sup>&</sup>lt;sup>11)</sup> not subject to production test, specified by design

 $<sup>^{12)}</sup>$  Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70 $\mu$ m thick) copper area for V\_bb connection. PCB is vertical without blown air.

<sup>&</sup>lt;sup>13)</sup> Requires 150 Ω resistor in GND connection. The reverse load current through the intrinsic drain-source diode has to be limited by the connected load. Note that the power dissipation is higher compared to normal operating conditions due to the voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! Input and Status currents have to be limited (see max. ratings page 1 and circuit page 7).



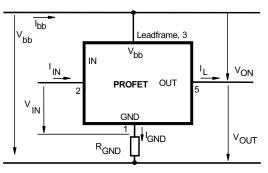
Parameter and Conditions	Symbol	Values			Unit
at $T_j$ =-40+150°C, $V_{bb}$ = 12 V unless otherwise specified		min	typ	max	
Input <sup>14)</sup>					
Input resistance see circuit page 7	R <sub>I</sub>	2.5	3.8	6.5	kΩ
Input turn-on threshold voltage	V <sub>IN(T+)</sub>	1.2		2.2	V
Input turn-off threshold voltage	V <sub>IN(T-)</sub>	0.8			V
Input threshold hysteresis	$\Delta V_{\rm IN(T)}$		0.3		V
Off state input current (pin 2) $V_{\rm IN} = 0.4$ V:	I <sub>IN(off)</sub>	1		15	μA
On state input current (pin 2) $V_{\rm IN} = 5$ V:	I <sub>IN(on)</sub>	4.5	12	24	μA

 $^{14)}\,$  If a ground resistor  $R_{GND}$  is used, add the voltage drop across this resistor.

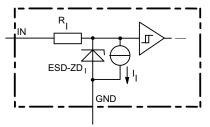
6



#### Terms

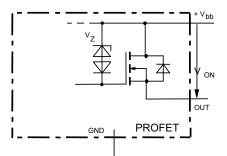


#### Input circuit (ESD protection)



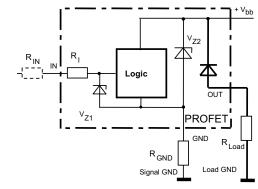
The use of ESD zener diodes as voltage clamp at DC conditions is not recommended.

#### Inductive and overvoltage output clamp



V<sub>ON</sub> clamped to 47 V typ.

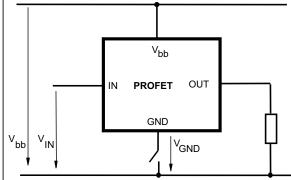
#### Overvolt. and reverse batt. protection



 $V_{Z1} = 6.1 \text{ V typ.}, V_{Z2} = 47 \text{ V typ.}, R_{GND} = 150 \Omega, R_{I} = 3.5 \text{ k}\Omega \text{ typ.}$ 

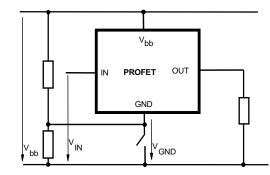
In case of reverse battery the load current has to be limited by the load. Temperature protection is not active

#### **GND disconnect**



Any kind of load. In case of Input=high is  $V_{OUT}\approx V_{IN}$  -  $V_{IN(T+)}$  .

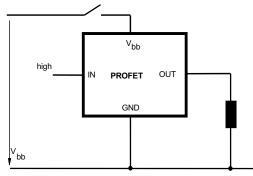
#### GND disconnect with GND pull up



Any kind of load. If  $V_{GND} > V_{IN} - V_{IN(T+)}$  device stays off



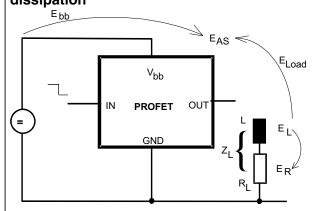
# V<sub>bb</sub> disconnect with charged inductive load



For inductive load currents up to the limits defined by  $Z_L$  (max. ratings and diagram on page 8) each switch is protected against loss of  $V_{bb}$ .

Consider at your PCB layout that in the case of Vbb disconnection with energized inductive load all the load current flows through the GND connection.

# Inductive load switch-off energy dissipation



Energy stored in load inductance:

 $E_{\rm L} = \frac{1}{2} \cdot {\rm L} \cdot {\rm I}_{\rm I}^2$ 

While demagnetizing load inductance, the energy dissipated in PROFET is

 $E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} \cdot i_L(t) dt,$ 

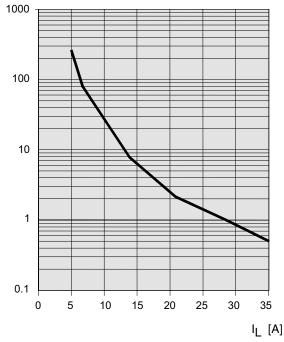
with an approximate solution for  $R_L > 0 \Omega$ :

$$E_{\text{AS}} = \frac{I_{\text{L}} \cdot L}{2 \cdot R_{\text{L}}} \left( V_{\text{bb}} + |V_{\text{OUT}(\text{CL})}| \right) ln \left( 1 + \frac{I_{\text{L}} \cdot R_{\text{L}}}{|V_{\text{OUT}(\text{CL})}|} \right)$$

# Maximum allowable load inductance for a single switch off

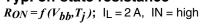
 $L = f(I_L)$ ; T<sub>j,start</sub> = 150°C, V<sub>bb</sub> = 12 V, R<sub>L</sub> = 0  $\Omega$ 

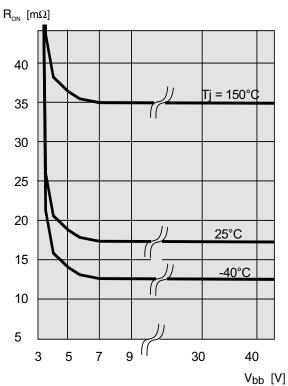
L [mH]





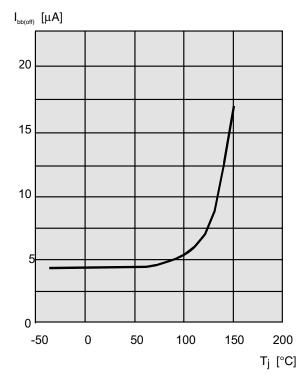
Typ. on-state resistance





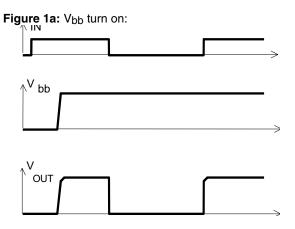
#### Typ. standby current

 $I_{bb(off)} = f(T_j)$ ; V<sub>bb</sub> = 9...34 V, IN1,2 = low





## **Timing diagrams**



proper turn on under all conditions

Figure 2a: Switching a resistive load, turn-on/off time and slew rate definition:

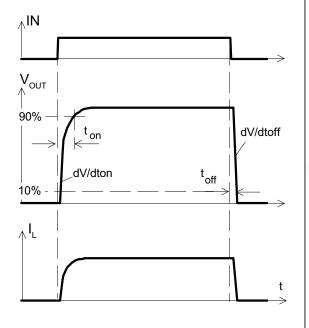
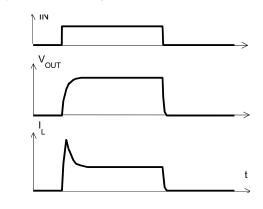
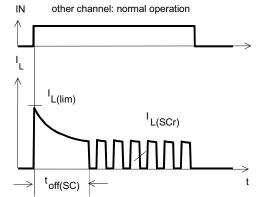


Figure 2b: Switching a lamp,



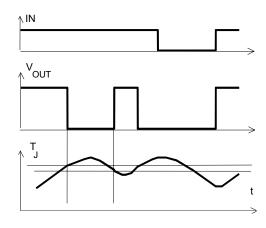
# Figure 3a: Short circuit shut down by overtemperature, reset by cooling



Heating up may require several milliseconds, depending on external conditions

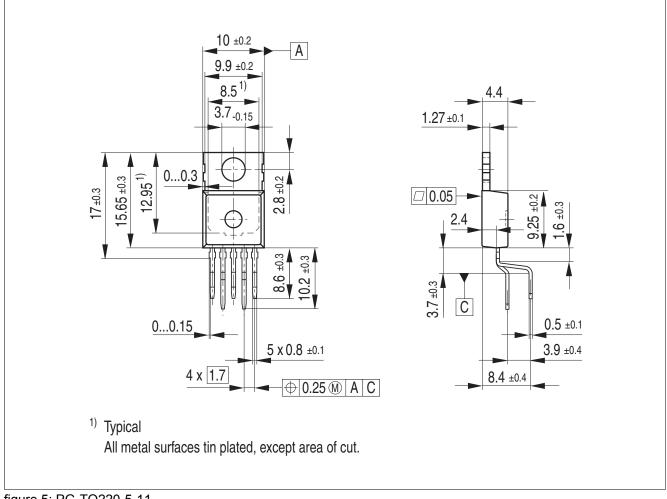
#### Figure 4a: Overtemperature:

Reset if  $T_j < T_{jt}$ 





## **Package Outlines**



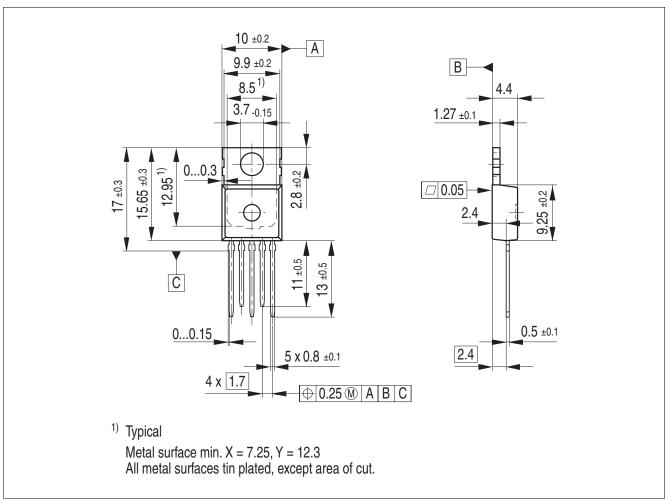
## figure 5: PG-TO220-5-11

#### **Green Product (RoHS compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on alternative packages, please visit our website: http://www.infineon.com/packages.







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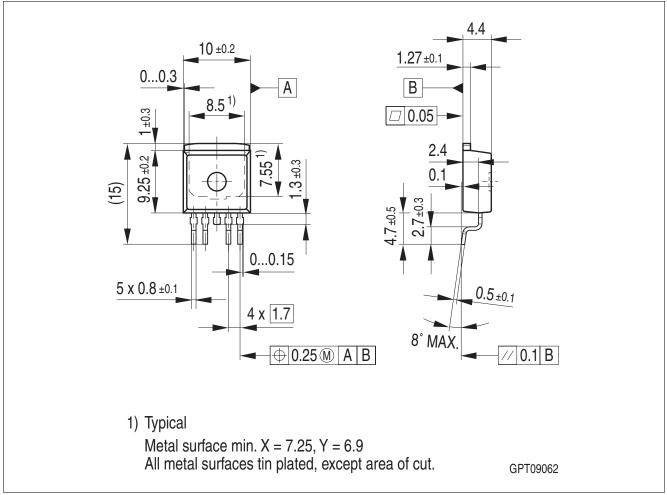
For further information on alternative packages, please visit our website: http://www.infineon.com/packages.

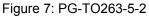
Dimensions in mm

Rev. 1.11, 2008-12-09

Data sheet







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Dimensions in mm

Rev. 1.11, 2008-12-09

Data sheet



## **Revision History**

Revision	Date	Changes
1.11	2008-12-09	RoHS-compliant PG-TO220 and PG-TO263 packages version of the BTS441TAll pages: Infineon logo updatedPage 1:Added "AEC qualified" and "RoHS" logo, added "Green Product (RoHScompliant)" and "AEC qualified" statement to feature list, package names changedto RoHS compliant versions, updated package drawing.Page 10-12:Package names changed to RoHS compliant versions ( PG-TO220-5-11, PG-TO220-12 and PG-TO263-5-2), added "Green Product" descriptionadded Revision Historyadded Legal Disclaimer

Edition 2008-12-09

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